

CBR04C569C5GACAUTO

CBR-SMD RF Auto COG, Ceramic, 5.6 pF, +/-0.25 pF, 50 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0402



Click here for the 3D model.

Chip Size 0402   L 1mm +/-0.05mm   W 0.5mm +/-0.05mm   T 0.5mm +/-0.05mm   B 0.25mm +/-0.1mm	Dimensions	
W 0.5mm +/-0.05mm   T 0.5mm +/-0.05mm	Chip Size	0402
T 0.5mm +/-0.05mm	L	1mm +/-0.05mm
	W	0.5mm +/-0.05mm
B 0.25mm +/-0.1mm	Т	0.5mm +/-0.05mm
	В	0.25mm +/-0.1mm

Packaging Specifications	tions	
Packaging	T&R, 180mm, Plastic Tape	
Packaging Quantity	10000	

General Information	
Series	CBR-SMD RF Auto COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Halogen Free	Yes
Notes	Solder Wave or Solder Reflow.
Shelf Life	78 Weeks
MSL	1

Specifications				
Capacitance	5.6 pF			
Capacitance Tolerance	+/-0.25 pF			
Voltage DC	50 VDC			
Dielectric Withstanding Voltage	125 VDC			
Temperature Range	-55/+125°C			
Temperature Coefficient	COG			
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MHz 1.0Vrms			
Dissipation Factor	0.2%1MHz 1.0Vrms			
Aging Rate	0% Loss/Decade Hour			
Insulation Resistance	10 GOhms			
Quality Factor	512			

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